



Product Change Notification

110332 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 110332 - 00
Change Title: Intel (R) Remote Management Module 3 kit
AXXRMM3LI, PCN 110332-00, Product
Design, Memory Flash Chip Change
Date of Publication: November 25, 2010

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jan 07, 2011
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Description of Change to the Customer:

The source part of AXXRMM3LI memory flash chip is changing to Winbond* E65762-001 because the original source Winbond* E45446-002 is discontinued.

The AXXRMM3LI PBA will change from E99685-303 to E99685-304.

Customer Impact of Change and Recommended Action:

Intel does not foresee any adverse customer impact to these changes. Intel recommends performing a standard level of evaluation as updated product becomes available.

Products Affected / Intel Ordering Codes:

Pre Change Product Code	Pre Change MM#	Pre Change TA	Pre Change PBA	Post Change Product Code	Post Change MM#	Post Change TA	Post Change PBA
AXXRMM3LI	908851	E99381-001	E99685-303	AXXRMM3LI	908851	E99381-002	E99685-304

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
November 25, 2010	00	Originally Published PCN